

A IS A THIRD IN THE WILL WE WILL BE SHOUTH TO SHOUTH THE SHOUTH TH **Leaded Inductors**

Series/Type: B82144A

The following products presented in this data sheet are being withdrawn.

| Ordering Code | Substitute Product | Date of Withdrawal | Deadline Last Orders | Last Shipments |
|-----------------|--------------------|--------------------|-------------------------|----------------|
| B82144A2984A000 | | 2016-02-26 | 2016-08-31 | 2017-02-28 |
| B82144A2535A300 | | 2016-02-26 | 2016-08-31 | 2017-02-28 |
| B82144A2305A500 | | 2016-02-26 | 2016-08-31 | 2017-02-28 |



| Ordering Code | Substitute Product | Date of Withdrawal | Deadline Last Orders | Last Shipments |
|-----------------|--------------------|--------------------|-------------------------|----------------|
| B82144A2265A000 | | 2016-02-26 | 2016-08-31 | 2017-02-28 |
| B82144A2145A500 | | 2016-02-26 | 2016-08-31 | 2017-02-28 |

For further information please contact your nearest EPCOS sales office, which will also support you in selecting a suitable substitute. The addresses of our worldwide sales network are presented at www.epcos.com/sales.

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LBC series, 5.2 x 12 (mm)

LBC choke (Large Bobbin Core)
Rated inductance 1 ... 100 000 μH
Rated current 20 ... 2200 mA

Construction

- Large ferrite drum core
- Winding: enamel copper wire
- Flame-retardant lacquer coating

Features

- Very wide inductance range
- High rated current
- Suitable for wave soldering
- RoHS-compatible

Applications

- RF blocking and filtering
- Decoupling and interference suppression
- For telecommunications (12- or 16-kHz blocking filter), automotive electronics, energy-saving lamps, entertainment electronics

Terminals

- Central axial leads
- Base material CuAg0.1
- Electroplated with nickel and pure tin

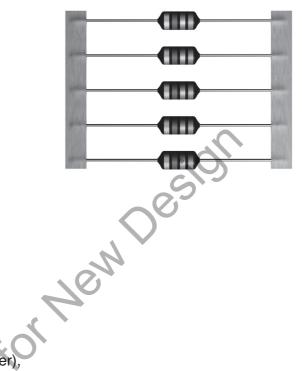
Marking

Inductance indicated by color bands to IEC 60062

Delivery mode and packing units

- Taped, Ammo and reel packing
- Packing units:

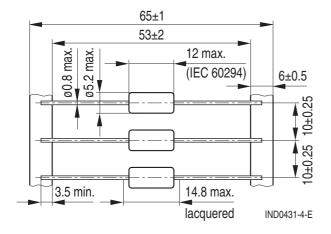
| 7 | Ammo (pcs./pack.) | Reel (pcs./reel) | | |
|-------|----------------------|---------------------|--|--|
| Axial | 1250 | 1500 | | |





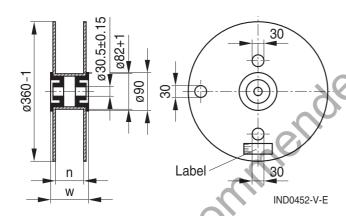
LBC series, 5.2 x 12 (mm)

Dimensional drawing

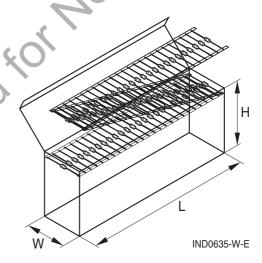


Dimensions in mm Minimum lead spacing 15 mm

Packing



n (mm): 72 +1 w (mm): 84 max



 $L \times W \times H$ (max. mm): $275 \times 80 \times 140$

Dimensions in mm



LBC series, 5.2 x 12 (mm)

Technical data and measuring conditions

| Rated inductance L _R | Measured with LCR meter Agilent 4284A or impedance analyzer Agilent 4294A | | | | | |
|--|---|--|--|--|--|--|
| | Measuring frequency: $L_R \le 10 \ \mu H$ = 1 MHz $10 \ \mu H < L_R \le 4700 \ \mu H$ = 100 kHz $L_R > 4700 \ \mu H$ = 10 kHz | | | | | |
| | Measuring current: ≤ 1 mA Measuring temperature: +20 °C | | | | | |
| Q factor Q _{min} | Measured with precision impedance analyzer Agilent 4294A, +20 °C | | | | | |
| Rated temperature T _R | +40 °C | | | | | |
| Rated current I _R | Maximum permissible DC current at rated temperature | | | | | |
| Inductance decrease ΔL/L ₀ | ≤ 10% (referred to initial value) at I _B , +20 °C | | | | | |
| DC resistance R _{max} | Measured at +20 °C | | | | | |
| Resonance frequency f _{res,min} | Measured with Agilent 4294A or 8753ES, +20 °C | | | | | |
| Solderability (lead-free) | Sn95.5Ag3.8Cu0.7: $+(245\pm5)$ °C, (3 ± 0.3) s Wetting of soldering area $\geq 90\%$ (to IEC 60068-2-20, test Ta) | | | | | |
| Resistance to soldering heat | +(260 ±5) °C, 10 s (to IEC 60068-2-20, test Tb) | | | | | |
| Tensile strength of leads | ≥ 20 N (to IEC 60068-2-21, test Ua) | | | | | |
| Climatic category | 55/125/56 (to IEC 60068-1) | | | | | |
| Storage conditions | Mounted: -55 °C +125 °C Packaged: -25 °C +40 °C, ≤ 75% RH | | | | | |
| Weight | Approx. 1.1 g | | | | | |

Mounting information

When bending the leads, take care that the start-of-winding areas at the face ends (protected by glue and lacquer) are not subjected to any mechanical stress.



LBC series, 5.2 x 12 (mm)

Characteristics and ordering codes

| L _R | Tolerance ¹⁾ | Q _{min} | f _Q | I _R | R _{max} | f _{res,min} | Ordering code (reel packing) ²⁾ |
|----------------|-------------------------|------------------|----------------|----------------|------------------|----------------------|--|
| μH | | 40 | MHz | mA | Ω | MHz | |
| 1.0 | ±10% ≙ K | 40 | 7.96 | 2200 | 0.08 | 200 | B82144A2102K000 |
| 1.5 | | 40 | 7.96 | 2100 | 0.09 | 190 | B82144A2152K000 |
| 2.2 | - | 40 | 7.96 | 1900 | 0.11 | 140 | B82144A2222K000 |
| 3.3 | | 40 | 7.96 | 1750 | 0.13 | 120 | B82144A2332K000 |
| 4.7 | | 40 | 7.96 | 1600 | 0.16 | 100 | B82144A2472K000 |
| 6.8 | | 40 | 7.96 | 1500 | 0.19 | 80 | B82144A2682K000 |
| 10 | | 60 | 2.52 | 1400 | 0.22 | 60 | B82144A2103K000 |
| 15 | | 60 | 2.52 | 1250 | 0.28 | 20 | B82144A2153K000 |
| 22 | | 50 | 2.52 | 1100 | 0.35 | 12 | B82144A2223K000 |
| 33 | ±5% ≙ J | 40 | 2.52 | 900 | 0.43 | 8.0 | B82144A2333J000 |
| 47 | | 40 | 2.52 | 800 | 0.50 | 5.0 | B82144A2473J000 |
| 68 | | 30 | 2.52 | 700 | 0.60 | 4.5 | B82144A2683J000 |
| 100 | | 50 | 0.796 | 600 | 0.70 | 3.5 | B82144A2104J000 |
| 150 | | 50 | 0.796 | 500 | 0.90 | 3.0 | B82144A2154J000 |
| 220 | | 50 | 0.796 | 400 | 1.60 | 2.4 | B82144A2224J000 |
| 330 | | 50 | 0.796 | 330 | 1.90 | 2.0 | B82144A2334J000 |
| 470 | | 40 | 0.796 | 280 | 2.50 | 1.5 | B82144A2474J000 |
| 680 | | 30 | 0.796 | 240 | 2.80 | 1.3 | B82144A2684J000 |
| 1000 | | 60 | 0.252 | 200 | 3.80 | 1.2 | B82144A2105J000 |
| 1500 | | 60 | 0.252 | 160 | 6.00 | 1.0 | B82144A2155J000 |
| 2200 | - 0 | 60 | 0.252 | 120 | 9.00 | 0.8 | B82144A2225J000 |
| 3300 | 20 | 60 | 0.252 | 110 | 12.0 | 0.6 | B82144A2335J000 |
| 4700 | X | 60 | 0.252 | 90 | 20.0 | 0.5 | B82144A2475J000 |
| 6800 | 10, | 60 | 0.252 | 80 | 30.0 | 0.4 | B82144A2685J000 |
| 10000 | | 50 | 0.0796 | 60 | 42.0 | 0.35 | B82144A2106J000 |
| 15000 | | 50 | 0.0796 | 50 | 68.0 | 0.30 | B82144A2156J000 |
| 22000 | | 50 | 0.0796 | 40 | 120 | 0.26 | B82144A2226J000 |
| 33000 | | 50 | 0.0796 | 35 | 150 | 0.22 | B82144A2336J000 |
| 47000 | | 40 | 0.0796 | 30 | 230 | 0.18 | B82144A2476J000 |
| 68000 | | 40 | 0.0796 | 25 | 290 | 0.15 | B82144A2686J000 |
| 100000 | | 30 | 0.0796 | 20 | 420 | 0.12 | B82144A2107J000 |

¹⁾ Closer tolerances on request.

²⁾ For Ammo pack the last digit has to be a »9«. Example: B82144A2102K009



LBC series, 5.2 x 12 (mm)

Characteristics and ordering codes

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|---|-----------|------------------|----------------|----------------|------------------|----------------------|---------------------------------|--|
| L _R | Tolerance | Q _{min} | f _Q | I _R | R _{max} | f _{res,min} | Ordering code (reel packing) 1) | |
| <u>μ</u> Η | | | MHz | mA | Ω | MHz | (reer packing) 17 | |
| For telecommunications in the blocking filter for 12-kHz and 16-kHz counting pulses | | | | | | | | |
| 980 | ±3% ≙ A | 25 | 0.016 | 200 | 3.8 | 1.2 | B82144A2984A000 | |
| 1450 | | 25 | 0.016 | 140 | 6.0 | 1.0 | B82144A2145A500 | |
| 2600 | | 20 | 0.012 | 120 | 11.0 | 0.7 | B82144A2265A000 | |
| 3050 | | 25 | 0.016 | 100 | 12.0 | 0.6 | B82144A2305A500 | |
| 5330 | | 20 | 0.012 | 90 | 25.0 | 0.5 | B82144A2535A300 | |
| | O'RE | com | nen | seo. | Or | | | |

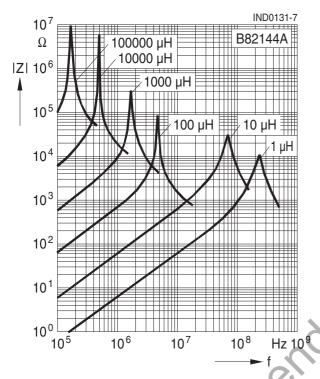
¹⁾ For Ammo pack the last digit has to be a »9«. Example: B82144A2336J009



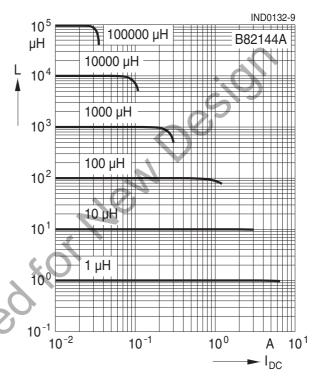
LBC series, 5.2 x 12 (mm)

Impedance |Z| versus frequency f

measured with impedance analyzer Agilent 4294A or S-parameter network analyzer Agilent 8753ES, typical values at +20 °C

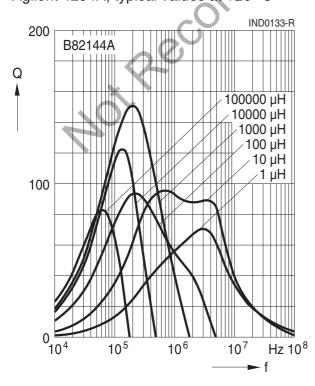


Inductance L versus DC load current I_{DC} measured with LCR meter Agilent 4284A, typical values at +20 °C

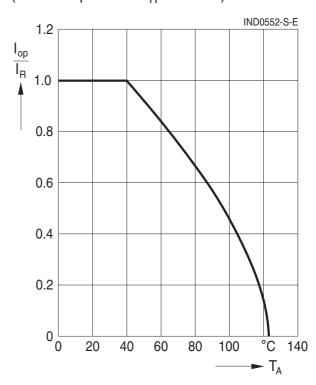


Q factor versus frequency f

measured with impedance analyzer Agilent 4294A, typical values at +20 °C



Current derating I_{op}/I_R versus ambient temperature TA (rated temperature $T_B = +40$ °C)





Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition), online catalogs and in the
 - Particular attention should be paid to the derating curves, if given. Derating applies in the case the ambient temperature in application exceeds the rated temperature of the component.
 - Ensure the operation temperature of the component in application not to exceed the maximum specified value or the upper climatic category temperature.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pins only. Temperatures specified in relation to reflow soldering can also refer to the pins or terminals for products with larger thermal mass, as in such cases, the temperature difference to the top of the component is too big (e.g., high proportion of core within the component).
- If the components are to be washed or varnished it is necessary to check whether the washing or varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. It is possible for washing or varnish agent residues to have a negative effect in the long-term on wire insulation.
 - Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted, sealed, or varnished in customer applications:
 - Many potting, sealing, or varnishing materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting, sealing, or varnishing materials used attack or destroy the wire, wire insulation, plastics or glue.
 - The effect of the potting, sealing, or varnishing materials may change the high-frequency behavior of the components.
 - Many coating materials have a negative effect (chemically and mechanically) on the winding wires, insulation materials and connecting points. Customers are always obliged to determine whether and to what extent their coating materials influence the component. Customers are responsible and bear all risk for the use of the coating material. TDK Electronics does not assume any liability for failures of our components that are caused by the coating material.
- Magnetic core materials such as ferrites are sensitive to direct impact. This can cause the core material to flake or lead to breakage of the magnetic core material.
- Any type of tension or pressure on the product may result in damage and affect its functionality and reliability.
 - The products are only to be attached to fixings or mounting holes provided for this purpose in accordance with the data sheet.
 - If additional mechanical forces are applied to the component, e.g., application of gap pads, it is necessary to check whether they attack or destroy any part of the component.
 - It is not permitted for the product specified in the data sheet to assume a mechanical function in the final application.
- Inductance value can drop if external metallic or magnetic parts will be put close to the coil or into the air gap of the coil or core or magnetic material.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



Cautions and warnings

Display of ordering codes for TDK Electronics products

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- We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3 The warnings, cautions and product-specific notes must be observed.
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Important notes

8 The trade names EPCOS, CarXield, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, FilterCap, FormFit, InsuGate, LeaXield, MediPlas, MiniBlue, MiniCell, MKD, MKK, ModCap, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PiezoBrush, PlasmaBrush, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SurfIND, ThermoFuse, WindCap, XieldCap are trademarks registered or pending in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

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